



February 2013 Rev. 1.0.0

GENERAL DESCRIPTION

The XRP7675 is a 3A capable synchronous current-mode PWM step down (buck) voltage regulator with improved light current load efficiency. A wide 4.5V to 18V input voltage range allows for single supply operations from industry standard 5V and 12V power rails.

With a 340kHz constant operating frequency integrated high and low-side and $100 \text{m}\Omega/100 \text{m}\Omega$ MOSFETS the XRP7675 reduces the overall component count and Current-mode footprint. provides fast transient response and cycle-bycycle OCP. An adjustable soft-start prevents inrush current at turn-on, and in shutdown mode the supply current drops to 0.1µA. At light current loads, the XRP7675 operates in Discontinuous Conduction Mode (DCM) and is frequency complemented pulse by а modulation mode (PFM) to provide excellent conversion efficiency.

Built-in output over-voltage (open load), over temperature, cycle-by-cycle over-current, under-voltage lockout (UVLO) and hiccup mode short-circuit protection insures safe operation under abnormal operating conditions.

The XRP7675 is offered in a RoHS compliant, "green"/halogen free 8-pin Exposed Pad SOIC package.

APPLICATIONS

- Distributed Power Architecture
- Portable Equipment
- Point of Load Converter
- Audio-Video Equipment

FEATURES

- 3A Continuous Output Current
- 4.5V to 18V Wide Input Voltage
 - 0.925V to 16V Adjustable Output Voltage
 - ±2% Output Voltage Accuracy
- PWM Current-Mode Control
 - 340kHz Constant Operations
 - Up to 95% Efficiency
- Light-Load Efficiency
 - Discontinuous Conduction Mode (DCM)
 - Pulse Frequency Modulation Mode (PFM)
- Programmable Soft-Start and Enable Function
- Built-in Thermal, Over-Current, UVLO, Output Over-Voltage and hiccup mode short-circuit protection
- RoHS Compliant, "Green"/Halogen
 Free 8-Pin Exposed Pad SOIC Package

TYPICAL APPLICATION DIAGRAM

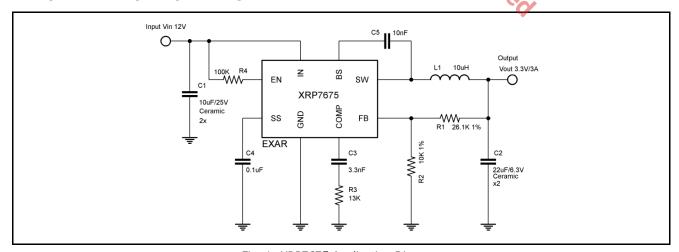


Fig. 1: XRP7675 Application Diagram



ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

| Supply Voltage V _{IN} | 0.3V to 20V |
|--------------------------------------|-------------|
| Switch Node Voltage V _{SW} | |
| Boost Voltage V _{BS} | |
| Enable Voltage V _{FN} | |
| All Other Pins | 0.3 to +6V |
| Junction Temperature | 150°C |
| Storage Temperature | |
| Lead Temperature (Soldering, 10 sec) | 260°C |
| ESD Rating (HBM - Human Body Model) | 2kV |
| ESD Rating (MM - Machine Model) | 200V |
| Moisture Sensitivity Level (MSL) | 3 |
| | |

OPERATING RATINGS

| Input Voltage V _{IN} | 4.5V to 18V |
|----------------------------------|--------------|
| Ambient Operating Temperature | 40°C to 85°C |
| Maximum Output Current | 3A min |
| Thermal Resistance θ_{JA} | 60°C/W |

ELECTRICAL SPECIFICATIONS

Specifications are for an Operating Ambient Temperature of $T_A = 25^{\circ}\text{C}$ only; limits applying over the full Ambient Operating Temperature range are denoted by a "•". Minimum and Maximum limits are guaranteed through test, design, or statistical correlation. Typical values represent the most likely parametric norm at $T_A = 25^{\circ}\text{C}$, and are provided for reference purposes only. Unless otherwise indicated, $V_{IN} = V_{EN} = 12V$, $V_{OUT} = 3.3V$.

| Parameter | Min. | Тур. | Max. | Units | | Conditions |
|--|-------|-------|-------|-------|-----|--|
| Shutdown Supply Current | | 0.1 | 0 10 | μΑ | | V _{EN} =0V |
| Quiescent Current | | 1.2 | 1.4 | CmA | S | V _{EN} =3V, V _{FB} =1V |
| Feedback Voltage V _{FB} | 0.907 | 0.925 | 0.943 | V | | • |
| Feedback Overvoltage Threshold | | 1.1 | 9 | V | | 0 |
| Feedback Bias Current | -0.1 | | 0.1 | QμA | 25 | V _{FB} =1V |
| Error Amplifier Voltage Gain A_{EA} 1 | | 400 | | V/V | | · • • • • • • • • • • • • • • • • • • • |
| Error Amplifier Transconductance G _{EA} | | 800 | | μΑ/V | 200 | 15 17 14 |
| COMP to Current Sense Transconductance G _{CS} | | 5.2 | | A/V | 9) | City Is |
| High-Side switch On Resistance R _{DSONH} ² | | 100 | | mΩ | | I _{SW} =0.2A&0.7A |
| Low-Side switch On Resistance R _{DSONL} ² | | 100 | | mΩ | | I _{SW} =-0.2A&-0.7A |
| High-Side switch Leakage Current | | 0.1 | 10 | μΑ | | V _{IN} =18V, V _{EN} =0V, V _{SW} =0V |
| High-Side Switch Current Limit | 4.3 | 5.6 | | Α | | |
| Low-Side Switch Current Limit | | 0 | | Α | | Drain to Source |
| Oscillator Frequency F _{OSC1} | 280 | 340 | 400 | kHz | | |
| Short Circuit Oscillator Frequency F _{OSC2} | | 90 | | kHz | | |
| Maximum Duty Cycle D _{MAX} | | 90 | | % | | V _{FB} =0.85V |
| Minimum Duty Cycle D _{MIN} | | | 0 | % | | V _{FB} =1V |
| Minimum Start-up Current | | 10 | | mA | | V _{IN} ≤4.75V |
| Minimum No Load Start-up Voltage | | 5 | | V | | I _{OUT} =0A |
| Minimum Full Load Start-up Voltage | | 5 | | V | | I _{OUT} =3A, V _{OUT} >3.0V |



| Parameter | Min. | Тур. | Max. | Units | Conditions |
|--|------|------|------|-------|---|
| EN Shutdown Threshold | 1.1 | 1.5 | 2 | V | |
| EN Shutdown Hysteresis ¹ | | 0.35 | | V | |
| EN Lockout Threshold | 2.2 | 2.5 | 2.7 | V | |
| EN Lockout Hysteresis | | 0.21 | | V | |
| UVLO Threshold | 3.65 | 4.00 | 4.25 | V | V _{IN} Rising |
| UVLO Hysteresis | | 0.20 | | V | |
| Soft-start Current | | 5 | | μA | |
| Soft-start Time ¹ | | 15 | | ms | C _{SS} =0.1µF, I _{OUT} =500mA |
| Thermal Shutdown ¹ | | 160 | | °C | |
| Thermal Shutdown Hysteresis ¹ | | 20 | | °C | |

Note 1: Guaranteed by design. Note 2: $R_{DSON} = (V_{SW1} - V_{SW2})/(I_{SW1} - I_{SW2})$

BLOCK DIAGRAM

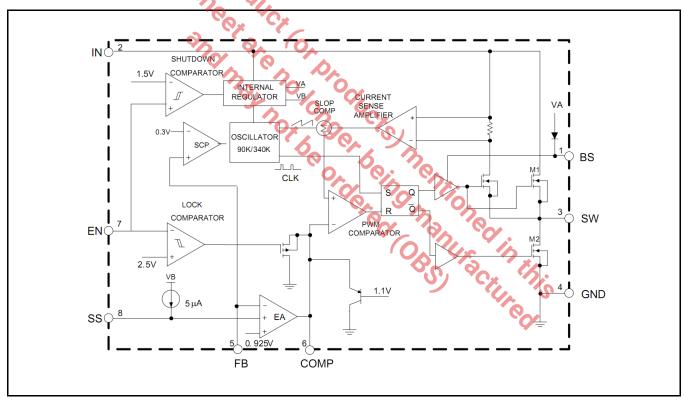
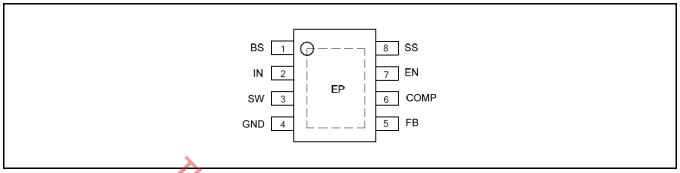


Fig. 2: XRP7675 Block Diagram



PIN ASSIGNMENT



PIN DESCRIPTION

| PIN DESCR | IPTION | Fig. 3: XRP7675 Pin Assignment (Exposed Pad SOIC-8) Description |
|-----------|-------------|---|
| Name | Pin Number | Description |
| BS | 1 | Bootstrap pin. Connect a $0.01\mu F$ or greater bootstrap capacitor between the BS pin and the SW pin. The voltage across the bootstrap capacitor drives the internal high-side power MOSFET. |
| IN | 2 | Power input pin. A capacitor should be connected between the IN pin and GND pin to keep the input voltage constant. |
| SW | 3 | Power switch output pin. This pin is connected to the inductor and the bootstrap capacitor. |
| GND | 4 | Ground pin. |
| FB | 5 | Feedback pin. An external resistor divider connected to FB programs the output voltage. If the feedback pin exceeds 1.1V the over-voltage protection will trigger. If the feedback voltage drops below 0.3V the oscillator frequency is lowered to achieve short-circuit protection. |
| СОМР | 6 | Compensation pin. This is the output of transconductance error amplifier and the input to the current comparator. It is used to compensate the control loop. Connect an RC network form this pin to GND. |
| EN | 7 | Control input pin. Drive EN high/low in order to turn on/off the regulator. When the IC is in shutdown mode all functions are disabled to decrease the supply current below 1 μ A. This input can be connected to VIN (pin 2) through a $100k\Omega$ resistor for automatic startup operations. |
| SS | 8 | Soft-start control input pin. Connect a capacitor from SS to GND to set the soft-start period. A 0.1µF capacitor sets the soft start period to 15ms. To disable the soft-start feature, leave SS unconnected. |
| GND | Exposed Pad | Connect to ground signal |

ORDERING INFORMATION

| Part Number | Temperature Range | Marking | Package | Packing Quantity | Note 1 | Note 2 |
|----------------|-----------------------------|------------------------|---------|---------------------|--------------------------------|--------|
| XRP7675IDBTR-F | -40°C≤T _A ≤+85°C | XRP7675I YYWWF X | HSOIC-8 | 2.5K/Tape & Reel | RoHS Compliant Halogen Free | |
| XRP7675EVB | XRP7675 Evaluation | Board | | | | |

[&]quot;YY'' = Year - "WW" = Work Week - "X" = Lot Number; when applicable.



TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at $V_{IN} = 12V$, $V_{OUT} = 3.3V$, $T_J = T_A = 25$ °C, unless otherwise specified - Schematic and BOM from Application Information section of this datasheet.

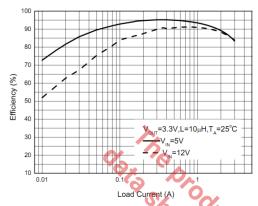


Fig. 4: Efficiency versus output current

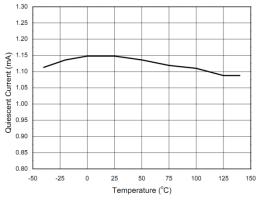


Fig. 5: Quiescent current versus temperature

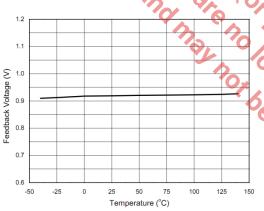


Fig. 6: Feedback voltage versus temperature

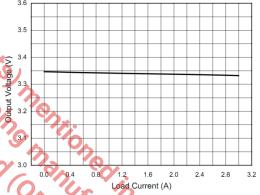


Fig. 7: Output voltage versus load current

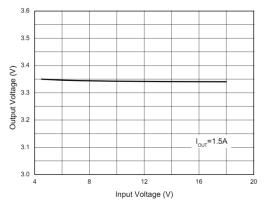


Fig. 8: Output voltage versus input voltage

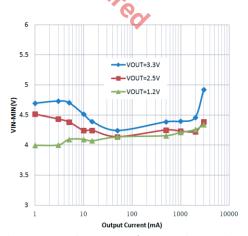
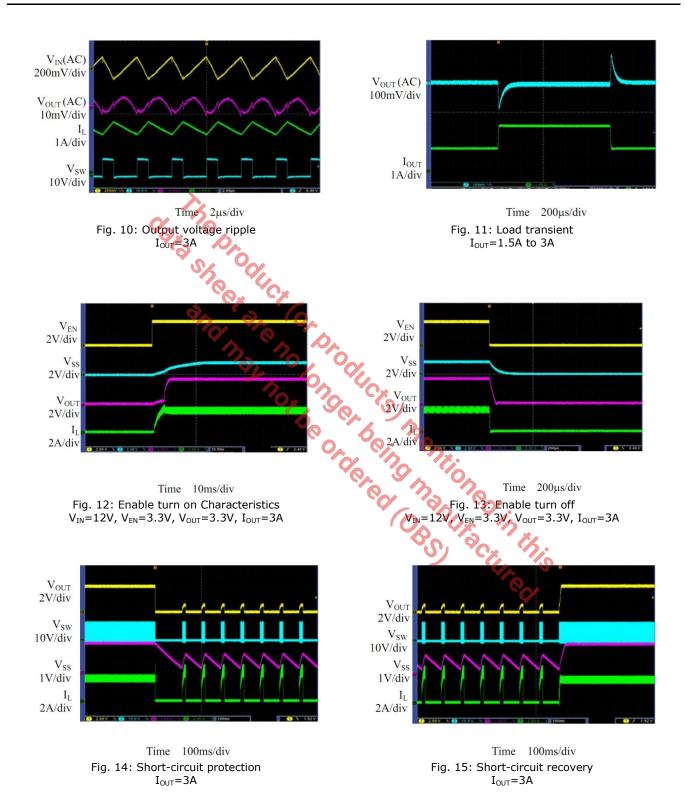


Fig. 9: Minimum Start-Up Voltage vs Output Current







THEORY OF OPERATION

FUNCTIONAL DESCRIPTION

The XRP7675 is a synchronous, current-mode, step-down regulator with light-load efficiency. The light-load efficiency is achieved by monitoring the current through M2 and turning it off when current drops below OA. The XRP7675 regulates input voltages from 4.5V to 18V and supplies up to 3A of load current. It uses current-mode control to regulate the output voltage. The output voltage measured at FB through a resistive voltage divider and input to a transconductance error amplifier. The high-side switch current is compared to the output of the error amplifier to control the output voltage. The regulator utilizes internal N-channel MOSFETs to stepdown the input voltage. A bootstrapping capacitor connected between BS and SW acts as a supply for high-side MOSFET. This capacitor is charged from the internal 5V supply when SW node is low. The XRP7675 has several powerful protection features including OCP, OVP, OTP, UVLO and output short-circuit.

PROGRAMMABLE SOFT-START

The soft-start time is fully programmable via CSS capacitor, placed between the SS and GND pin. The CSS is charged by a 5μ A constant-current source, generating a ramp signal fed into non-inverting input of the error amplifier. This ramp regulates the voltage on comp pin during the regulator startup, thus realizing soft-start. Calculate the required CSS from:

$$CSS \approx tss \times \frac{5\mu A}{V_{FB}}$$

Where:

tss is the required soft-start time

V_{FB} is the feedback voltage (0.925V nominal)

Please note that the above is a simplified equation and will provide an approximate CSS value. For a required soft-start, a more accurate CSS can be determined based on empirical data.

OVERCURRENT PROTECTION AND HICCUP MODE

The OCP protects against accidental increase in load current or a short circuit. The current of internal switch M1 is monitored. If this current exceeds 5.6A typical then a hiccup mode is triggered. In hiccup mode, internal power FETs are turned off and the SS pin is discharged. When SS reaches 0.2V a softstart is initiated. The regulator will stay in hiccup mode until overcurrent is removed. Note that when the soft start pin is below approximately 0.5V the regulator switching frequency is 90kHz.

OVERVOLTAGE PROTECTION OVP

The XRP7675 has internal OVP. When V_{OUT} exceeds the OVP threshold (when V_{FB} exceeds 1.1V) the power switching will be turned off. The XRP7675 will restart when overvoltage condition is removed.

OVER-TEMPERATURE PROTECTION OTP

If the junction temperature exceeds 160°C the OTP circuit is triggered, turning off the internal control circuit and switched M1 and M2. When junction temperature drops below 140°C the XRP7675 will restart.



APPLICATION INFORMATION

SETTING THE OUTPUT VOLTAGE

Use an external resistor divider to set the output voltage. Program the output voltage from:

$$R1 = R2 \times \left(\frac{V_{OUT}}{0.925V} - 1\right)$$

Where:

R1 is the resistor between V_{OUT} and FB

R2 is the resistor between FB and GND (nominally $10k\Omega$)

0.925V is the nominal feedback voltage.

OUTPUT INDUCTOR

Select the output inductor for inductance L, DC current rating I_{DC} and saturation current rating I_{SAT} . I_{DC} should be larger than regulator output current. I_{SAT} , as a rule of thumb, should be 50% higher than the regulator output current. Since the regulator is rated at 2A then $I_{DC} \ge 2A$ and $I_{SAT} \ge 3A$. Calculate the inductance from:

$$L = (V_{IN} - V_{OUT}) \left(\frac{V_{OUT}}{\Delta I_L \times f_s \times V_{IN}} \right)$$

Where:

 ΔI_L is peak-to-peak inductor current ripple nominally set to 30%-40% of I_{OUT}

f_S is nominal switching frequency (340kHz)

As an example, inductor values for several common output voltages are shown in tables 1 and 2.

| VOUT(V) | ΔI _{L(p-p)} (A) | L(µH) | Inductor Example |
|---------|--------------------------|-------|---------------------|
| 5.0 | 0.9 | 10 | 744314101 |
| 3.3 | 0.7 | 10 | 744314101 |
| 2.5 | 0.6 | 10 | 744314101 |
| 1.8 | 0.6 | 7.6 | 744314760 |
| 1.5 | 0.5 | 7.6 | 744314760 |
| 1.2 | 0.6 | 4.9 | 744314490 |

Table 1: Suggested inductor values for VIN=12V and IOUT=3A

| VOUT(V) | $\Delta I_{L(p-p)}(A)$ | L(µH) | Inductor Example |
|---------|------------------------|-------|---------------------|
| 3.3 | 0.7 | 4.9 | 744314490 |
| 2.5 | 0.8 | 4.9 | 744314490 |
| 1.8 | 0.7 | 4.9 | 744314490 |
| 1.5 | 0.6 | 4.9 | 744314490 |
| 1.2 | 0.5 | 4.9 | 744314490 |

Table 2: Suggested inductor values for VIN=5V and IOUT=3A

OUTPUT CAPACITOR COUT

Select the output capacitor for voltage rating, capacitance C_{OUT} and Equivalent Resistance ESR. The voltage rating, as a rule of thumb, should be at least twice the output voltage. When calculating the required the capacitance, usually overridina requirement is current load-step transient. If the unloading transient (i.e., when load transitions from a high to a low current) is met, then usually the loading transient (when load transitions from a low to a high current) is met as well. Therefore calculate the C_{OUT} based on the unloading transient requirement from:

$$C_{OUT} = L \times \left(\frac{I_{High}^2 - I_{Low}^2}{(V_{OUT} + V_{transient})^2 - V_{OUT}^2}\right)$$

Where:

L is the inductance calculated in the preceding step

 I_{High} is the value of load-step prior to unloading. This is nominally set equal to regulator current rating (3A).

 I_{Low} is the value of load-step after unloading. This is nominally set equal to 50% of regulator current rating (1.5A).

 $V_{transient}$ is the maximum permissible voltage transient corresponding to the load step mentioned above. $V_{transient}$ is typically specified from 3% to 5% of V_{OUT} .

ESR of the capacitor has to be selected such that the output voltage ripple requirement ΔV_{OUT} , nominally 1% of V_{OUT} , is met. Voltage ripple ΔV_{OUT} is mainly composed of two components: the resistive ripple due to ESR and capacitive ripple due to C_{OUT} charge transfer. For applications requiring low voltage ripple, ceramic capacitors are recommended



because of their low ESR which is typically in the range of $5m\Omega$. Therefore ΔV_{OUT} is mainly capacitive. For ceramic capacitors calculate the ΔV_{OUT} from:

$$\Delta V_{OUT} = \frac{\Delta I_L}{8 \times C_{OUT} \times f_s}$$

Where:

 ΔI_L is from table 1 or 2 in previous section

C_{OUT} is the value calculated above

f_s is nominal switching frequency (340kHz)

If tantalum or electrolytic capacitors are used then ΔV_{OUT} is essentially a function of ESR:

$$\Delta V_{OUT} = \Delta I_L \times ESR$$

INPUT CAPACITOR CIN

Select the input capacitor for voltage rating, RMS current rating and capacitance. The voltage rating should be at least 50% higher than the regulator's maximum input voltage. Calculate the capacitor's current rating from:

$$I_{CIN.RMS} = I_{OUT} \times \sqrt{D \times (1 - D)}$$

Where:

 I_{OUT} is regulator's maximum current (2A)

D is duty cycle ($D=V_{OUT}/V_{IN}$)

Calculate the C_{IN} capacitance from:

$$C_{IN} = \frac{I_{OUT} \times V_{OUT} \times (V_{IN} - V_{OUT})}{f_c \times {V_{IN}}^2 \times \Delta V_{IN}}$$

Where:

 ΔV_{IN} is the permissible input voltage ripple, nominally set at 1% of V_{IN}

OPTIONAL SCHOTTKY DIODE

An optional Schottky diode may be paralleled between the GND pin and SW pin to improve the regulator efficiency. See Table 3.

| Part Number | Voltage/Current Rating | Vendor |
|-------------|---------------------------|----------------------------|
| B130 | 30V/1A | Diodes, Inc. |
| SK13 | 30V/1A | Diodes, Inc. |
| MBRS130 | 30V/1A | International Rectifier |

Table 3: Optional Schottky diode

EXTERNAL BOOTSTRAP DIODE

A low-cost diode, such as 1N4148, may provide higher efficiency when the input voltage is 5V or the output is 5V or 3.3V. Circuit configuration is shown in figures 16 and 17. The external bootstrap diode is also recommended where duty cycle (V_{OUT}/V_{IN}) is larger than 65%.

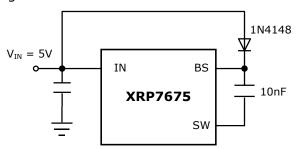


Fig. 16: Optional external bootstrap diode where input voltage is fixed 5V

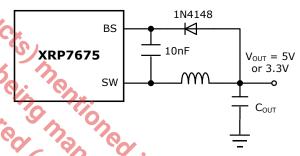


Fig. 17: Optional external bootstrap diode where output voltage is 5V or 3.3V

LOOP COMPENSATION

XRP7675 utilizes current-mode control. This using a minimum of components to compensate the regulator. In general only two components are needed: RC and CC. Proper compensation of the regulator (determining RC and CC) results in optimum transient response. In terms of power supply control theory, the goals of compensation are to choose RC and CC such that the regulator loop gain has a crossover frequency fc between 15kHz and 34kHz. The corresponding phase-margin should be between 45 degrees and 65 degrees. An important characteristic of current-mode buck regulator is its dominant pole. The frequency of the dominant pole is given by:



$$f_p = \frac{1}{2\pi \times C_{OUT} \times R_{load}}$$

where R_{load} is the output load resistance.

The uncompensated regulator has a constant gain up to its pole frequency, beyond which the gain decreases at -20dB/decade. The zero arising from the output capacitor's ESR is inconsequential if ceramic C_{OUT} is used. This simplifies the compensation. The RC and CC, which are placed between the output of XRP7675's Error Amplifier and ground, constitute a zero. The frequency of this compensating zero is given by:

$$f_z = \frac{1}{2\pi \times RC \times CC}$$

For the typical application circuit, RC=13k Ω CC=4.7nF provide а satisfactory compensation. The XRP7675 can also be used as a pin to pin upgrade replacement for XRP7665 based designs; in this instance, the recommended RC network for XRP7665, RC=6.8k and CC=3.9nF, can be used with satisfactory results with the XRP7675. Please contact EXAR if you need assistance with the compensation of your particular circuit.

TYPICAL APPLICATION

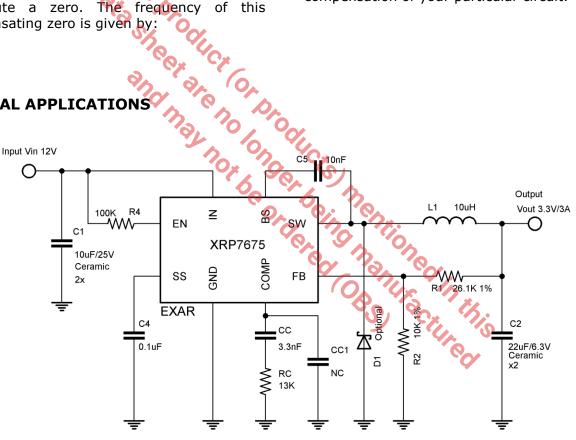


Fig. 18: XRP7675 Typical Application Diagram - 12V to 3.3V Conversion

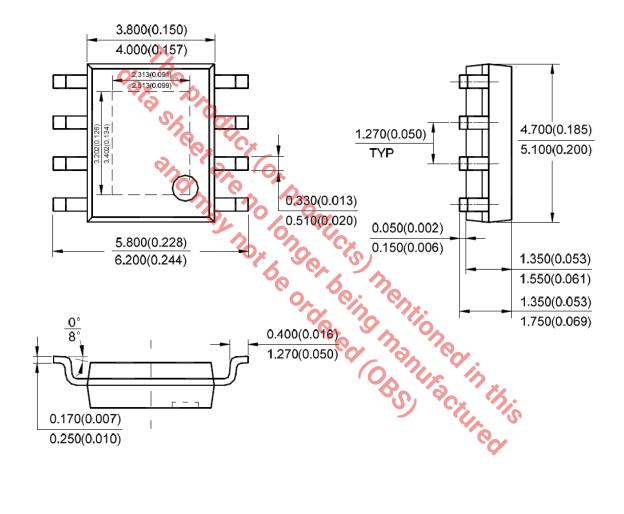


PACKAGE SPECIFICATION

8-PIN SOIC EXPOSED PAD

Unit: mm (inch)

Eject hole, oriented hole and mold mark are optional.





REVISION HISTORY

| Revision | Date | Description |
|----------|------------|------------------------------|
| 1.0.0 | 02/28/2013 | Initial release of datasheet |
| | | |
| | | |

FOR FURTHER ASSISTANCE Fmail: -antation: htt

customersupport@exar.com

powertechsupport@exar.com

http://www.exar.com/TechDoc/default.aspx?



EXAR CORPORATION

HEADQUARTERS AND SALES OFFICES

48720 Kato Road

Fremont, CA 94538 - US

Tel.: +1 (510) 668-7000

Fax: +1 (510) 668-7030

www.exar.com

NOTICE

EXAR Corporation reserves the right to make changes to the products contained in this publication in order to improve design, performance or reliability. EXAR Corporation assumes no responsibility for the use of any circuits described herein, conveys no license under any patent or other right, and makes no representation that the circuits are free of patent infringement. Charts and schedules contained here in are only for illustration purposes and may vary depending upon a user's specific application. While the information in this publication has been carefully checked; no responsibility, however, is assumed for inaccuracies.

EXAR Corporation does not recommend the use of any of its products in life support applications where the failure or malfunction of the product can reasonably be expected to cause failure of the life support system or to significantly affect its safety or effectiveness. Products are not authorized for use in such applications unless EXAR Corporation receives, in writing, assurances to its satisfaction that: (a) the risk of injury or damage has been minimized; (b) the user assumes all such risks; (c) potential liability of EXAR Corporation is adequately protected under the circumstances.

Reproduction, in part or whole, without the prior written consent of EXAR Corporation is prohibited.